

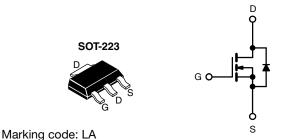
Vishay Siliconix

HALOGEN

FREE

Power MOSFET

PRODUCT SUMMA	RY	
V _{DS} (V)	60	
$R_{DS(on)}(\Omega)$	$V_{GS} = 5.0 \text{ V}$	0.20
Q _g max. (nC)	8.4	
Q _{gs} (nC)	3.5	
Q _{gd} (nC)	6.0	
Configuration	Sing	le



N-Channel MOSFET

FEATURES

- Surface mount
- · Available in tape and reel
- Dynamic dV/dt rating
- · Logic-level gate drive
- R_{DS(on)} specified at V_{GS} = 4 V and 5 V
- Fast switching
- Ease of paralleling
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The SOT-223 package is designed for surface-mounting using vapor phase, infrared, or wave soldering techniques. Its unique package design allows for easy automatic pick-and-place as with other SOT or SOIC packages but has the added advantage of improved thermal performance due to an enlarged tab for heatsinking. Power dissipation of greater than 1.25 W is possible in a typical surface mount application.

ORDERING INFORMATION	
Package	SOT-223
Lead (Pb)-free and Halogen-free	SiHLL014TR-GE3
Lead (Pb)-free	IRLL014TRPbF a

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, un	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	60	V		
Gate-Source Voltage		V_{GS}	± 10	7 v		
Continuous Drain Current	V at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	I-	2.7		
Continuous Drain Current	V _{GS} at 10 V	T _C = 100 °C	00 °C 1 _D 1.7		Α	
Pulsed Drain Current ^a			I _{DM}	22		
Linear Derating Factor				0.025	W/°C	
Linear Derating Factor (PCB mount) e				0.017	017 W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	100	mJ	
Repetitive Avalanche Current ^a			I _{AR}	2.7	Α	
Repetitive Avalanche Energy ^a		E _{AR}	0.31	mJ		
Maximum Power Dissipation	T _C =	T _C = 25 °C		3.1	W	
Maximum Power Dissipation (PCB mount) e	T _A =	T _A = 25 °C		2.0	T vv	
Peak Diode Recovery dV/dt ^c		dV/dt	4.5	V/ns		
Operating Junction and Storage Temperature Range	е		T _J , T _{stg} -55 to +150 °C			
Soldering Recommendations (Peak temperature) d	for	10 s	-	300	7	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 16 mH, R_g = 25 Ω , I_{AS} = 2.7 A (see fig. 12).
- c. $I_{SD} \le 10$ A, $dI/dt \le 90$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).



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THERMAL RESISTANCE RAT	INGS				
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient (PCB mount) ^a	R _{thJA}	-	-	60	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	40	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static				l	l	I.		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	60	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.073	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	1.0	-	2.0	V	
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 10 V	-	-	± 100	nA	
Zara Cata Valtaga Drain Current		V _{DS} :	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$		-	25		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 48 \text{ V}$	V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA	
Drain-Source On-State Resistance	В	V _{GS} = 5.0 V	I _D = 1.6 A ^b	-	-	0.20		
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 4.0 V	I _D = 1.4 A ^b	=.	-	0.28	Ω	
Forward Transconductance	9 _{fs}	V _{DS} :	= 25 V, I _D = 1.6 A	3.2	-	-	S	
Dynamic								
Input Capacitance	C _{iss}	$V_{GS} = 0 V$,		-	400	-		
Output Capacitance	C _{oss}		$V_{DS} = 25 \text{ V},$	-	170	-	pF	
Reverse Transfer Capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5	-	42	-		
Total Gate Charge	Qg			-	-	8.4		
Gate-Source Charge	Q _{gs}	V _{GS} = 5.0 V	$I_D = 10 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 b	-	-	3.5	nC	
Gate-Drain Charge	Q _{gd}		See lig. 6 and 16	-	-	6.0		
Turn-On Delay Time	t _{d(on)}			=.	9.3	-		
Rise Time	t _r	V _{DD} :	= 30 V, I _D = 10 A,	=	110	-		
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 30 \text{ V, } I_{D} = 10 \text{ A,}$ $R_{g} = 12 \Omega, R_{D} = 2.8 \Omega, \text{ see fig. } 10 \text{ b}$ - 17		-	ns			
Fall Time	t _f			-	26	-		
Internal Drain Inductance	L _D	Between lead 6 mm (0.25") f		-	4.0	-	الم	
Internal Source Inductance	L _S	package and center of die contact		-	6.0	-	- nH	
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol showing the		-	2.7		
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction		-	-	22	A	
Body Diode Voltage	V _{SD}	T _J = 25 °C	$I_{S} = 2.7 \text{ A}, V_{GS} = 0 \text{ V}^{\text{ b}}$	-	-	1.6	V	
Body Diode Reverse Recovery Time	t _{rr}	T 05 00 1	10 A all/at 100 A/ h	-	65	130	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	$I_J = 25 \text{ °C, I}_F$	= 10 A, dl/dt = 100 A/µs ^b	-	0.33	0.65	μC	
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	y L _S and	L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

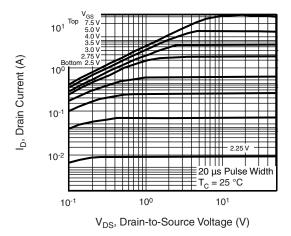


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

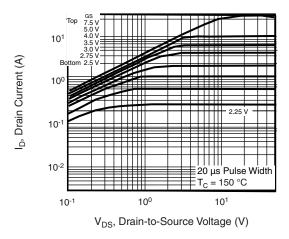


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

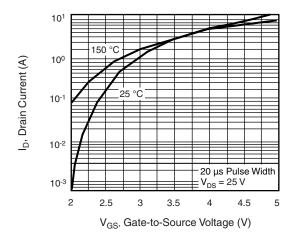


Fig. 3 - Typical Transfer Characteristics

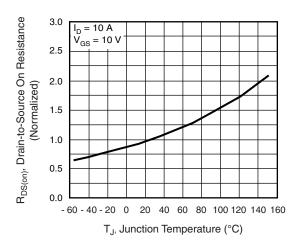


Fig. 4 - Normalized On-Resistance vs. Temperature

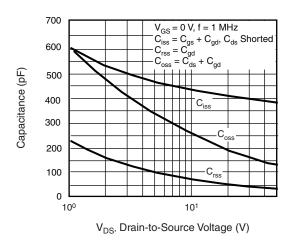


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

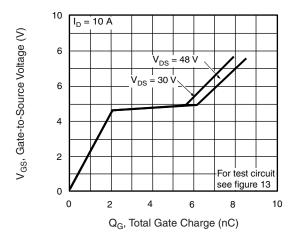


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



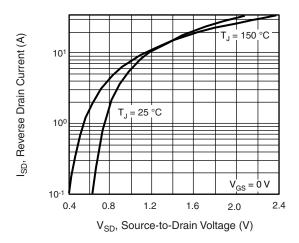


Fig. 7 - Typical Source-Drain Diode Forward Voltage

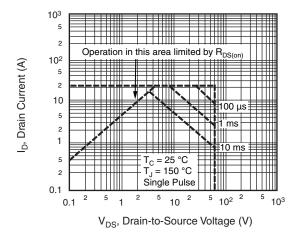


Fig. 8 - Maximum Safe Operating Area

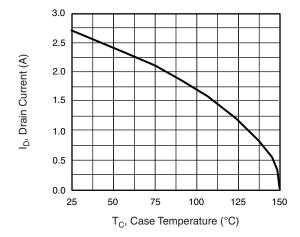


Fig. 9 - Maximum Drain Current vs. Case Temperature

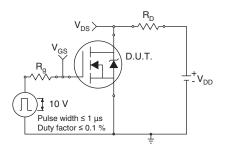


Fig. 10a - Switching Time Test Circuit

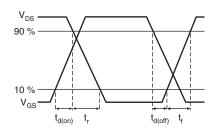


Fig. 10b - Switching Time Waveforms



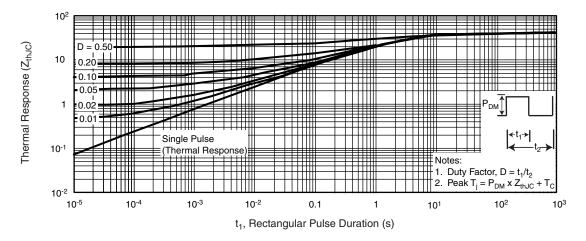


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

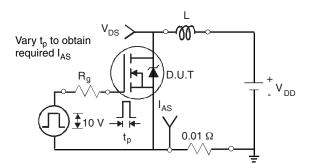


Fig. 12a - Unclamped Inductive Test Circuit

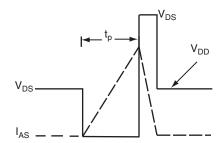


Fig. 12b - Unclamped Inductive Waveforms

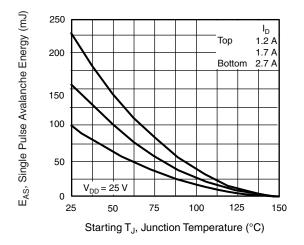


Fig. 12c - Maximum Avalanche Energy vs. Drain Current



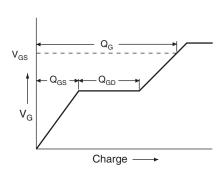


Fig. 13a - Basic Gate Charge Waveform

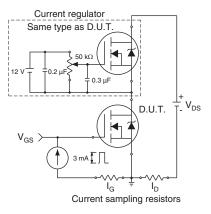
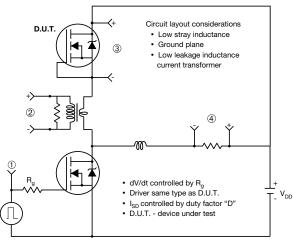


Fig. 13b - Gate Charge Test Circuit

Peak Diode Recovery dV/dt Test Circuit



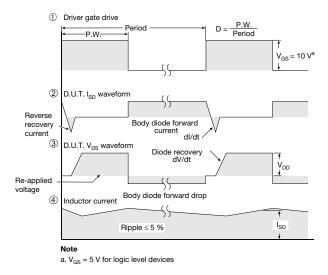


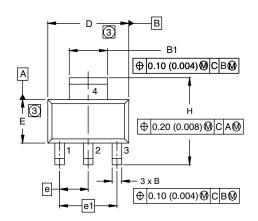
Fig. 14 - For N-Channel

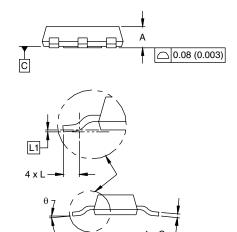
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SOT-223 (HIGH VOLTAGE)





DIM.	MILLI	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	1.55	1.80	0.061	0.071	
В	0.65	0.85	0.026	0.033	
B1	2.95	3.15	0.116	0.124	
С	0.25	0.35	0.010	0.014	
D	6.30	6.70	0.248	0.264	
E	3.30	3.70	0.130	0.146	
е	2.30 BSC		0.0905 BSC		
e1	4.60	O BSC	0.181	BSC	
Н	6.71	7.29	0.264	0.287	
L	0.91	-	0.036	=	
L1	0.061 BSC		0.0024	BSC	
θ	-	10'	-	10'	

ECN: S-82109-Rev. A, 15-Sep-08

DWG: 5969

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension do not include mold flash.
- 4. Outline conforms to JEDEC outline TO-261AA.

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